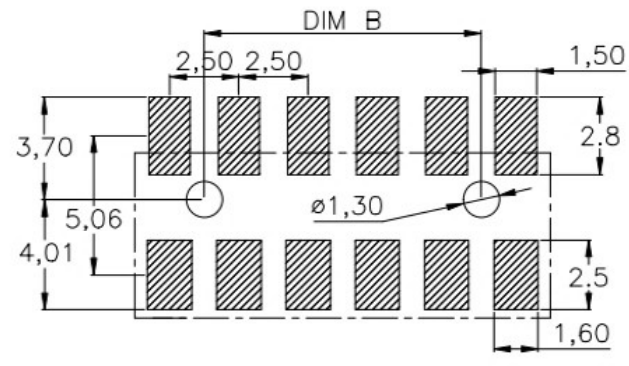
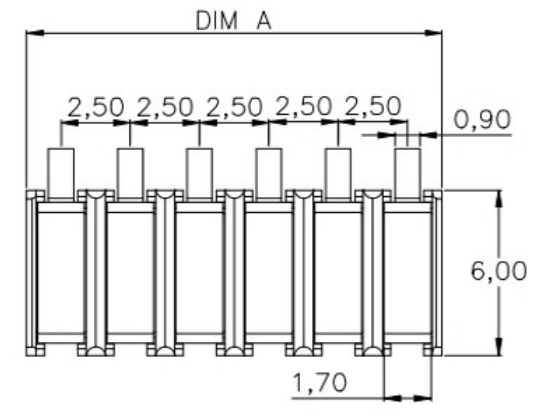
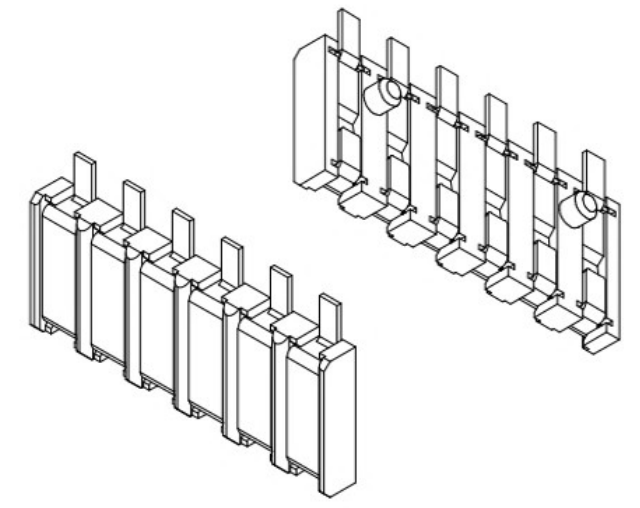
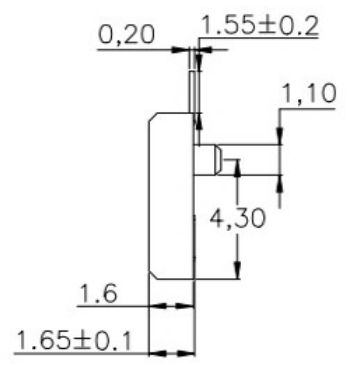
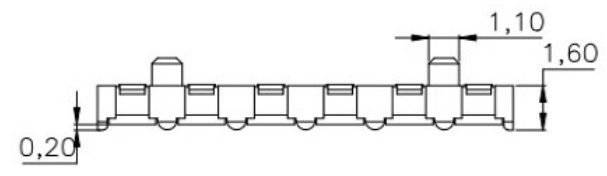
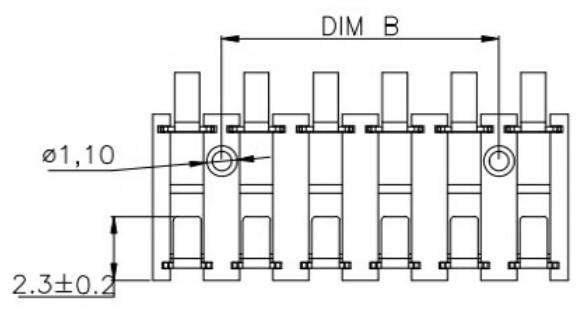


REV.	ECN NO.	DESCRIPTION	DESIGN	DATE
A		INITIAL	Kai	2018.03.29



RECOMMENDED PCB LAYOUT

DIM A	DIM B
5.0	
7.5	2.5
10.0	5.0
12.5	7.5
15	10.0



性能:
 额定电流: 2.0A
 额定电压: 12V
 耐电压: 500V
 接触电阻: 30mΩ
 绝缘电阻: 500MΩ
 工作温度: -40℃~+85℃
 塑件(材质): LCP
 接触点(材质): 磷铜, 镀金

②	HOUSING	1	LCP		BLACK
①	CONTACT A	2	PHOSPHOR BRONZE 0.20T	Au PLATED	
ITEM	PART NAME	Q'TY	MATERTAL	DESCRIPTION	REMARK

UNLESS OTHERWISE SPECIFIED TOLERANCES				东莞市高迪电子有限公司			
DECIMALS:		ANGLES:		DWG NO.	PART NAME:		
				DESIGN:	PART NO.		
				CHECK:			
				APPROVED			
DIM	TOL	DIM	TOL	REV.	UNIT:	SHEET:	
X.	±0.50	X.	±2°	A	mm	1/1	
X.X	±0.30	X.X	±1°				
X.XX	±0.20	X.XX					
X.XXX	±0.10	X.XXX					